

User Manual for the HE693RTD600-24

Resistance Temperature Device Input Module

First Edition 31 December 1998

MAN0279-01

PREFACE

This manual explains how to use the Horner APG's Resistance Temperature Device Input Module.

Copyright (C) 1998 Horner APG, LLC., 640 North Sherman Drive, Indianapolis, Indiana 46201. All rights reserved. No part of this publication may be reproduced, transmitted, transcribed, stored in a retrieval system, or translated into any language or computer language, in any form by any means, electronic, mechanical, magnetic, optical, chemical, manual or otherwise, without the prior agreement and written permission of Horner APG, LLC.

All software described in this document or media is also copyrighted material subject to the terms and conditions of the Horner Software License Agreement.

Information in this document is subject to change without notice and does not represent a commitment on the part of Horner APG, LLC.

LogicMaster is a trademark of GE Fanuc.

For user manual updates, contact Horner Electric APG, Technical Support Division, at (317) 916-4274 or visit our website at www.heapg.com.

LIMITED WARRANTY AND LIMITATION OF LIABILITY

Horner APG, LLC. ("HE") warrants to the original purchaser that the Resistance Temperature Device Input module manufactured by HE is free from defects in material and workmanship under normal use and service. The obligation of HE under this warranty shall be limited to the repair or exchange of any part or parts which may prove defective under normal use and service within two (2) years from the date of manufacture or eighteen (18) months from the date of installation by the original purchaser whichever occurs first, such defect to be disclosed to the satisfaction of HE after examination by HE of the allegedly defective part or parts. THIS WARRANTY IS EXPRESSLY IN LIEU OF ALL OTHER WARRANTIES EXPRESSED OR IMPLIED INCLUDING THE WARRANTIES OF MERCHANTABILITY AND FITNESS FOR USE AND OF ALL OTHER OBLIGATIONS OR LIABILITIES AND HE NEITHER ASSUMES, NOR AUTHORIZES ANY OTHER PERSON TO ASSUME FOR HE, ANY OTHER LIABILITY IN CONNECTION WITH THE SALE OF THIS RESISTANCE TEMPERATURE DEVICE INPUT MODULE. THIS WARRANTY SHALL NOT APPLY TO THIS RESISTANCE TEMPERATURE DEVICE INPUT MODULE OR ANY PART THEREOF WHICH HAS BEEN SUBJECT TO ACCIDENT, NEGLIGENCE, ALTERATION, ABUSE, OR MISUSE. HE MAKES NO WARRANTY WHATSOEVER IN RESPECT TO ACCESSORIES OR PARTS NOT SUPPLIED BY HE. THE TERM "ORIGINAL PURCHASER", AS USED IN THIS WARRANTY, SHALL BE DEEMED TO MEAN THAT PERSON FOR WHOM THE RESISTANCE TEMPERATURE DEVICE INPUT MODULE IS ORIGINALLY INSTALLED. THIS WARRANTY SHALL APPLY ONLY WITHIN THE BOUNDARIES OF THE CONTINENTAL UNITED STATES.

In no event, whether as a result of breach of contract, warranty, tort (including negligence) or otherwise, shall HE or its suppliers be liable of any special, consequential, incidental or penal damages including, but not limited to, loss of profit or revenues, loss of use of the products or any associated equipment, damage to associated equipment, cost of capital, cost of substitute products, facilities, services or replacement power, down time costs, or claims of original purchaser's customers for such damages.

To obtain warranty service, return the product to your distributor with a description of the problem, proof of purchase, post paid, insured and in a suitable package.

ABOUT PROGRAMMING EXAMPLES

Any example programs and program segments in this manual or provided on accompanying diskettes are included solely for illustrative purposes. Due to the many variables and requirements associated with any particular installation, Horner APG cannot assume responsibility or liability for actual use based on the examples and diagrams. It is the sole responsibility of the system designer utilizing the Resistance Temperature Device Input module to appropriately design the end system, to appropriately integrate the Resistance Temperature Device Input module and to make safety provisions for the end equipment as is usual and customary in industrial applications as defined in any codes or standards which apply.

Note: The programming examples shown in this manual are for illustrative purposes only. Proper machine operation is the sole responsibility of the system integrator.

TABLE OF CONTENTS

| 2 |
|----|
| 3 |
| 3 |
| 4 |
| 6 |
| 6 |
| 7 |
| 8 |
| 8 |
| 8 |
| 10 |
| 11 |
| 11 |
| 12 |
| 12 |
| 13 |
| 13 |
| 13 |
| |

THIS PAGE INTENTIONALLY LEFT BLANK

CHAPTER 1: DESCRIPTION

1.1 **Product Description**

The RTD Input Modules allow RTD temperature sensors to be directly connected to the PLC without external signal processing (transducers, transmitters, etc.). All analog and digital processing of the RTD signal is performed on the module, and temperature values in 0.5°C or 0.5°F increments are written to the 90-30 %AI input table. All modules feature six channels, and support PT-90 (MIL-7990), PT-100 (alpha=.00385, .003902 and .03906), Ni-120, Cu-10, Cu-50, Cu-53, Cu-100, Pt-1000, TD5R and Linear Resistance.

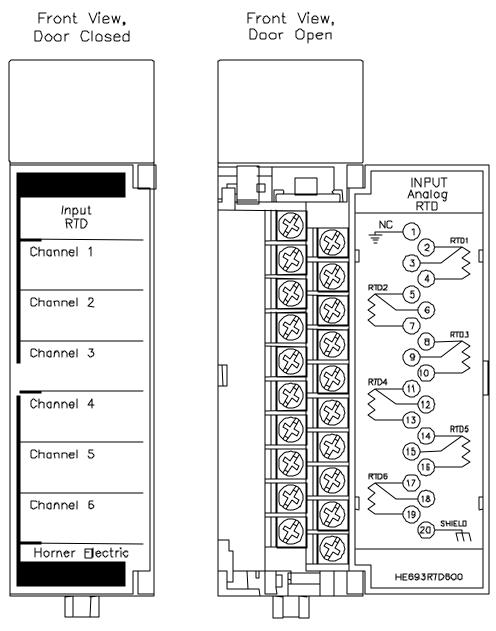


Figure 1.1 – Front

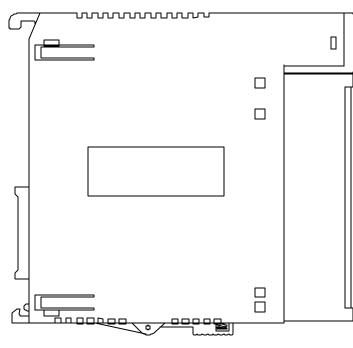


Figure 1.2 – Side View

RTD600.DWG

1.2 Specifications

| | Table 1.1 - HE693RTD600-24 Specifications | | | | | | | |
|-----------------------------|---|--------------------------------|--------------------------------|---|--|--|--|--|
| Power Consumption (Typical) | | 75mA @ 5VDC Number of Channels | | 6 | | | | |
| | Pt-100E | -200 to 850°C | I/O Points Required | 6%AI | | | | |
| | Pt-100C | -100 to 650°C | Input Impedance | >1000 Meg Ω | | | | |
| | Pt-100Z | -200 to 300°C | Fault Protection | Zener Diode Clamp | | | | |
| | Pt-1000 | -100 to 850°C | A/D Conversion Type | 16 bit, Integrating | | | | |
| | Cu-10 | -200 to 260°C | Update Time | 50 Channels per second | | | | |
| Cu-50 | | 0 to 100°C | Average RTD current, PT-100 | 330 microamps | | | | |
| | Cu-53 | -200 to 260°C | Channel to Channel Tracking | 0.1°C | | | | |
| | Cu-100 | -200 to 200°C | Resolution | 0.5°C or 0.5°F | | | | |
| Types Ni-120 Supported | | -100 to 270°C | Accuracy | ± 0.5°C typical, ± 1.0°C for Cu-10 and TD5R | | | | |
| | Linear | 0 to 200Ω | Operating Temperature | 0 to 60°C (32° to 140°F) | | | | |
| | TD5R | -40 to 150°C | Relative Humidity | 5% to 95% non- condensing | | | | |
| | Pt-90 (MIL-7990) | -50 to 200°C | | | | | | |

Side View

CHAPTER 2: CONFIGURATION

2.1 GENERAL

Chapter Two describes the procedures and set-up for I/O configuration using LogicMaster™ software.

2.2 Configuration

1. Upon entering the LogicMaster[™] 90 Software, select 'LogicMaster Configuration Package' (F2) from the menu.

| MICRO 90-20 90-30 90-70 | etup 10 Exit |
|--|--------------|
| LOGICMASTER 90 SOFTWARE For Series 90 (c) programmable controllers | _ |
| Shift-F1 Series 90 Micro Programmable Controller Shift-F2 Series 90-20 Programmable Controller Shift-F3 Series 90-30 Programmable Controller Shift-F5 Series 90-70 Programmable Controller | |
| F1 Logicmaster 90 Programmer Package F2 Logicmaster 90 Configuration Package F3 PCM Development Package (PCOP) F4 Axis Positioning Module Package F5 Operator Interface Utilities F6 C Development Utilities F7 Logicmaster 90 Utilities F8 User Command Menu F9 Logicmaster 90 Setup Package F10 Exit to DOS | |
| Use the Shift-function keys to select PLC type. Use the function keys to start software package. | - |
| Figure 2.1 – Default Screen | |

2. To reach the configuration screen, select 'I/O Configuration' (F1), from the menu

| ER | IES | 90-30 / | 90-20 | 7 MI | CRO | C O | NF | I G | U R | A T | I |) N | S 0 | F | τW | łA | R |
|----|-----|---|-------------|-------|----------------|----------------|---------------|-----------|------|-----|---|-----|-----|---|----|----|---|
| | | | Vers | ion (| 5.01 | Dire | ct S | eri | al - | COM | I | | | | | | |
| | | F1 I/O Configuration F2 CPU Configuration F3 PLC Control and Status | | | | | | | | | | | | | | | |
| | | | 7 8 9 | Pi | rogra tilit | im Fo :y: L | lder .oad/ | Fu Sto | ncti | ons | | | | | | | |
| | | F1 | 10 | Pi | rint | Func | tior | 15 | | | | | | | | | |

Figure 2.2 – Configuration Screen

3. Move cursor to the designated slot containing the module and select 'Other' (F8).

| RACK COPY REF VU DELETE UNDEL 1 <u>m30 io</u> 2genius 3 4ps 5rcksel 6 <u>comm</u> > | 7 8 <mark>other 9 10</mark> zoom |
|---|----------------------------------|
| > PS/CPU 1 2 3 4 5 ======= PROGRAMMED CONFIGURATION = 5 PWR321 CPU 30 | |

31 DEC 1998

Figure 2.3 – Rack Configuration

4. From the following screen, select 'Foreign' (F3) .

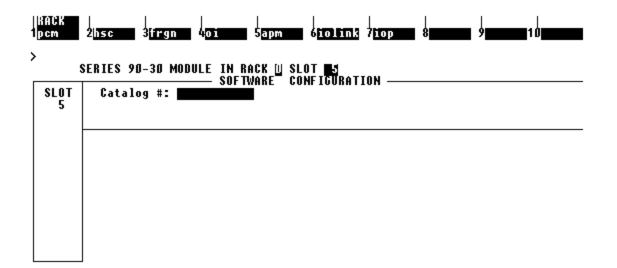
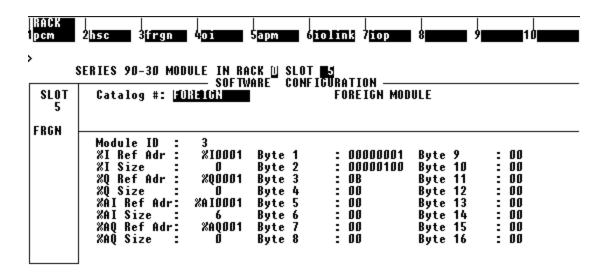
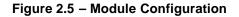


Figure 2.4 – Slot Configuration

5. The screen appears as shown in Figure 2.5:





2.2.1 Configuration Parameters

Tables 2.1 and 2.2 indicate the five necessary parameters for configuring the HE693RTD600-24. The parameters include % AI Size, Byte 1, Byte 2, Byte 3, and Byte 4.

Change the various bytes (1-4) and set %AI to '6' to reach the desired set-up.

| Table 2.1 – Configuration Parameters for RTD600-24 | | | | | | | |
|--|--------|-------------|------------|----------|--|--|--|
| %AI Size | Byte 1 | Byte 2 | Byte 3 | Byte 4 | | | |
| | | | 00=Pt-100E | | | | |
| | | | 01=Ni-120 | | | | |
| | | | 02=Pt-100C | | | | |
| | | | 03=Cu-10 | | | | |
| | | 0000 | 04=LIN100 | 00=0.5°C | | | |
| 6 | 0001 | thru | 05=Pt-1000 | 01=0.5°F | | | |
| | | 0111 | 06=TD5R | | | | |
| | | (see chart) | 07=Pt-100Z | | | | |
| | | | 08=Cu-50 | | | | |
| | | | 09=Cu-53 | | | | |
| | | | 0A=Cu-100 | | | | |
| | | | 0B=Pt-90 | | | | |

2.2.2 Digital Filtering

The effect of digital filtering (on the HE693RTD600-24 module) in response to a temperature change is graphically represented in Figure 2.6. (*%temp change completed vs. time*). Byte 2 sets the amount of digital filtering.

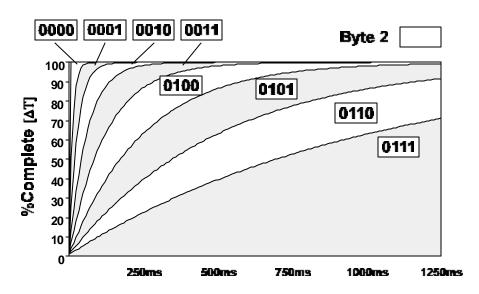


Figure 2.6 - The Effects of Digital Filtering

2.2.3 Temperature Scaling

The Resistance Temperature Device reports values to the %AI table in 0.5 increments in either °C or °F. Conversion to actual degrees can be calculated using Table 2.3.

| Note: the module configuration depends on | the parameter assigned to Byte 4. |
|---|-----------------------------------|
|---|-----------------------------------|

| Table 2.3 - Temperature Scaling | | | | | | |
|--|-------------|--|--|--|--|--|
| Module | Temperature | | | | | |
| Configuration | Conversion | | | | | |
| 0.5°C | °C=%AI/2 | | | | | |
| 0.5°F | °F=%Al/2 | | | | | |
| LIN100 reports 128 counts per 1 Ω . | | | | | | |

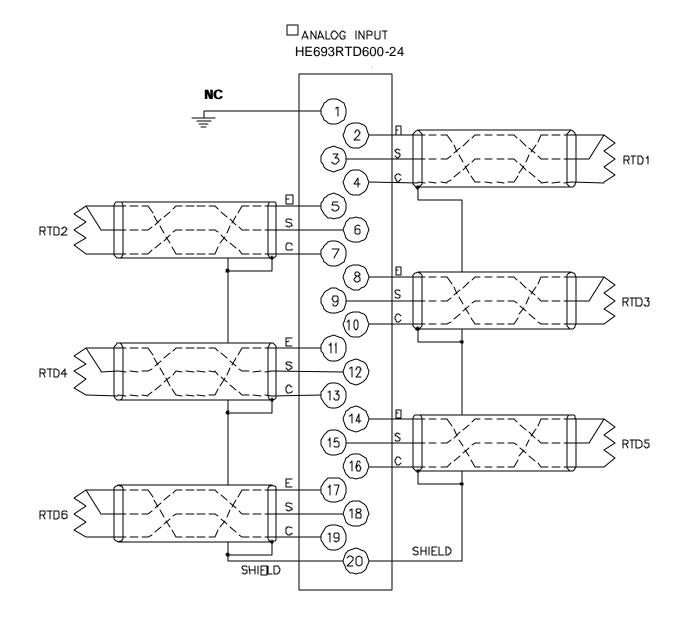
Examples:

If %AI2 equals Channel 2 on the RTD module, and %AI2 equals 1,000 and Byte 4 equals 00, the temperature reading is T=500°C (format .5°C).

If %AI2equals 142 and Byte 4 equals 01 (.5°F), the temperature is T=71°F.

CHAPTER 3: WIRING & INSTALLATION

3.1 Wiring Diagram for the RTD Terminal Block Connection





3.1.1 Three-Wire Connection

Figure 3.2 shows how to make a three-wire connection with an RTD module. (Refer to Figure 3.1.)

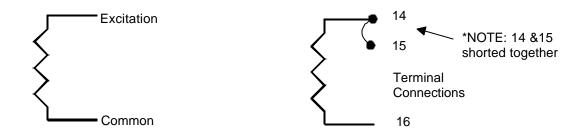


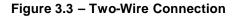
Figure 3.2 – Three-Wire Connection

3.1.2 Two-Wire Connection

Figure 3.3 shows how to make a two-wire connection with an RTD module. (Refer to the Figure 3.1.)

For example, Channel 5:





NOTE: Two-wire RTDs are supported, but accuracy may vary. Four-Wire RTD's are <u>NOT</u> supported

3.2 Installation Requirements

- a. Wiring should be routed in its own conduit.
- b Shielded, twisted wiring offers the best noise immunity.
- c. If shielded wiring is used, a good earth ground connection (on one end only) is critical.
- c. If shields are connected at the module end, terminals 1 or 20 may be used as the shield ground point.
- d. The lead resistance of each wire should be no more than 50Ω .
- e. All unused channels should be shorted together and connected to pins 1 or 20.